

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kazuhiro TSUCHIDA</td> <td>10/22/2007</td> </tr> <tr> <td>Masaaki YAMAYA</td> <td>10/22/2007</td> </tr> </tbody> </table>		Name	Execution Date	Kazuhiro TSUCHIDA	10/22/2007	Masaaki YAMAYA	10/22/2007
Name	Execution Date						
Kazuhiro TSUCHIDA	10/22/2007						
Masaaki YAMAYA	10/22/2007						
RECEIVING PARTY DATA							
Name:	Shin-Etsu Chemical Co., Ltd.						
Street Address:	6-1, Otemachi 2-chome, Chiyoda-ku,						
City:	Tokyo						
State/Country:	JAPAN						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11945554</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11945554		
Property Type	Number						
Application Number:	11945554						
CORRESPONDENCE DATA							
Fax Number:	(202)822-1111						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	2028221100						
Email:	PatentMail@Whda.com						
Correspondent Name:	Westerman, Hattori, Daniels & Adrian LLP						
Address Line 1:	1250 Connecticut Avenue NW,						
Address Line 2:	Suite 700						
Address Line 4:	Washington,, DISTRICT OF COLUMBIA 20036						
ATTORNEY DOCKET NUMBER:	072459						
NAME OF SUBMITTER:	Sadao Kinashi						
Total Attachments: 1 source=072459_Assignment#page1.tif							

OP \$40.00 11945554

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

(Insert ASSIGNEE's Name(s) Address(es))

Shin-Etsu Chemical Co., Ltd.
6-1, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

Water-Soluble Silicon-Containing Polymer, Making Method, Coating Composition, and Coated Article

(*If the assignment is being filed after the filing of the application, this section must be completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

* filed on _____ Serial No. _____

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

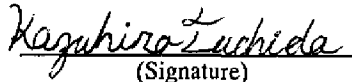
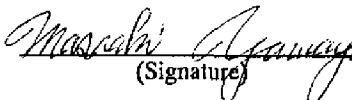
and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

 (Signature)	Kazuhiro TSUCHIDA (Type Name)	October 22, 2007 (Date)
 (Signature)	Masaaki YAMAYA (Type Name)	October 22, 2007 (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)

NO LEGALIZATION REQUIRED